



BOARD CHARACTERISTICS

Copper Layer Count:	4	Board Thickness:	1.6000 mm
Board overall dimensions:	119.3800 mm x 62.4840 mm	Min hole diameter:	0.1524 mm
Min track/spacing:	0.1524 mm / 0.1524 mm	Impedance Control:	No
Copper Finish:	ENIG	Plated Board Edge:	No
Castellated pads:	No		
Edge card connectors:	No		

Stackup: all layers 1 oz copper.
Total board thickness 0.062 inch.

Contact: Thanasi Pantazides / +1 952 686 1930 / panta013@umn.edu

Sheet:

File: power.kicad_pcb

Title: FOXSI power

Size: USLetter | Date: Oct 24 2023

KiCad E.D.A. kicad 7.0.1-0

Rev: v3

Id: 1/1